| ABSOCIATION CONNECTING<br>ELECTRONICS (MOUSTRIESS)<br>MOUSTRIESS | nockburn, Illinois. A   | Il rights reserved un ntions. | nder both    | This docume<br>level parts, t  | ent is a declaration | ion of the s<br>encompasse                | ubstances<br>es all lowe | within the manufacture revealed a second sec | rer listed i<br>which the r     | tem. Note:<br>nanufacture      | if the item is an as<br>r has engineering | ssembly with lower responsibility. |  |
|--|---|-------------------------------|--------------|--|----------------------|---|--------------------------|--|---------------------------------|--------------------------------|---|------------------------------------|--|
|  | IPC Web Site for Information on IPC-1752 Standard Form<br>http://www.ipc.org/IPC-175x Distril |                               |              | e * Declaration Class *<br>Class 6 - RoHS Yes/No, Homogeneous Materi |                      |   |                          | ials and M   | als and Mfg Information         |                                |   |                                    |  |
| Supplier Information   |   |                               |              |  |                      |   |                          |  |                                 |                                |   |                                    |  |
| Company name* Company unique ID                                  |   |                               | Unique I     |  |                      | ie ID Authority                           |                          |  | Respon                          | Response Date*                 |   |                                    |  |
| nsemi  |   |                               |              |  |                      |   |                          |  | 2025-06-06                      |                                |   |                                    |  |
| Contact Name   | tact Name Title - Contact   |                               |              | ]  | Phone - Contact*     |   |                          |  | Email - Contact*                |                                |   |                                    |  |
| roduct-Env-Stewards Product Enviro Compliance                    |   |                               | NA           |  |                      |   | Prod                     |  | Produc                          | roduct-Env-Stewards@onsemi.com |   |                                    |  |
| Authorized Representative* Title - Representative                |   |                               |              | Phone - Representative*  |                      |   |                          | Email - Representative*  |                                 |                                |   |                                    |  |
| Product-Env-Stewards Product Enviro Compli                       |   |                               | Compliance   |  | NA                   |   |                          | Produc   | Product-Env-Stewards@onsemi.com |                                |   |                                    |  |
| Requester Item Number Mf   | r Item Number   | Mfr Item Name                 |              |  | Effective Date       | e Version                                 | ]                        | Manufacturing Site   |                                 | Weight*                        | UOM                                       | Unit Type                          |  |
| SB   | AV70LT1G  | LT1G SS SOT23 SWCH D          |              |  | 2025-06-06           | CN1                                       |                          | CN1  |                                 | 8.02                           | mg  | Each                               |  |
| Manufacturing Proccess Information                               |   |                               |              |  | •                    |   |                          |  |                                 |                                | ·   |                                    |  |
| Terminal Plating / Grid Array Material                           | Terminal Base   | Alloy J                       | -STD-020 MSL | Rating   | Peak Pro             | Process Body Temperature Max Time at Peak |                          | Temperature Number o   |                                 | ber of Reflow Cy               | cles                                      |                                    |  |
| Matte Tin (Sn) - annealed CU Alloy 1                             |   | 1                             |              | 260  |                      | С   | 30                       | secor  | nds 3                           |                                |   |                                    |  |
| Comments   |   |                               |              |  |                      |   |                          |  |                                 |                                |   |                                    |  |
| level 1 - maximum time at peak temperature duri                  | ng soldering is 10-3  | 0 seconds                     |              |  |                      |   |                          |  |                                 |                                |   |                                    |  |
| For more information regarding material compos                   | sition please refer to  | page 3                        |              |  |                      |   |                          |  |                                 |                                |   |                                    |  |

| RoHS Material Composition Declaration  |  |  |   | Declaration Type *   | Detailed  |  |  |  |  |  |
|--|--|--|---|--|---|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  | RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP). |  |   |  |   |  |  |  |  |  |
| cadmium, hexavalentchromium, polybrominate<br>contains a RoHS restricted substance inexcess<br>encompass all such components. Supplier certif<br>as of the date that Supplier completes this form<br>Company acknowledges that Supplier may hav<br>independently verified information provided by<br>certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip<br>of an applicable quantity limit, please ir<br>ies that it gathered the information it pro-<br>.Supplier acknowledges that Company<br>e relied on informationprovided by othe<br>v others, Supplier agrees that, at a minin<br>and the Supplier enter into a written agre<br>pource of the Supplier's liability and the   | henyl ethers (each a "<br>ndicate below which, i<br>ovides in this form us<br>will rely on this certifiers<br>in completing this<br>num, itssuppliers have<br>eement with respect to<br>Company's remedies | RoHS restricted substance") in exce<br>if any, RoHS exemption you believe<br>ing appropriate methods to ensure if<br>ication in determining the complian<br>form, and that Supplier may not have<br>e provided certifications regarding the<br>to the identified part, the terms and cc<br>for issues that arise regarding inform   | ts accuracy and that such information is true and<br>ce of its products with European Union membe<br>ve independently verified such information. How<br>heir contributions to the part, and those certifica<br>anditions of that agreement, including any warr | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>l correct to the best of its knowledge and belief,<br>r state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>tions are at least as comprehensive as the<br>anty rights and/or remedies provided as part of |  |  |  |  |  |
| RoHS Declaration * 1 - Item(s)   | does not contain RoHS restricted substa  | ances per the definitio  | ny, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall<br>appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief,<br>tion in determining the compliance of its products with European Union member state laws that implement the RoHS Directive.<br>m, and that Supplier may not have independently verified such information. However, in situations where Supplier has not<br>rovided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the<br>ne identified part,the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of<br>issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the<br>all apply. |  |   |  |  |  |  |  |
| Exemption: If the declared item does not con applicable exemptions.  | ntain RoHS restricted substances per   | the definition above   | except for defined RoHS exempti   | ons, then select the corresponding response i  | n the RoHS Declaration above and choose all   |  |  |  |  |  |
| Exemption List Version   | EL-2011/534/EU   |  |   |  |   |  |  |  |  |  |
| Declaration Signature  |  |  |   |  |   |  |  |  |  |  |
| Instructions: Complete all of the required fin<br>Requester) and click on Submit Form to have  | elds on all pages of this form. Select the form returned to the Requester  | he "Accepted" on th  | e Supplier Acceptance drop-down   | . This will display the signature area. Digital  | lly sign the declaration (if required by the  |  |  |  |  |  |
| Supplier Digital Signature Ra  | stislav Drska  | Le   |   |  |   |  |  |  |  |  |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| Homogeneous Material | Weight | Unit of Measure | Level    | Substance  | CAS         | Exempt | Weight | Unit of Measure |
|----------------------|--------|-----------------|----------|--|-------------|--------|--------|-----------------|
| Die                  | 0.05   | mg              | Supplier | Silicon (Si)   | 7440-21-3   |        | 0.05   | mg              |
| Lead Frame           | 2.92   | mg              | В        | Nickel (Ni)  | 7440-02-0   |        | 1.06   | mg              |
|                      |        |                 | Supplier | Iron (Fe)  | 7439-89-6   |        | 1.4658 | mg              |
|                      |        |                 | Supplier | Copper (Cu)  | 7440-50-8   |        | 0.3942 | mg              |
| Mold Compound-Black  | 4.9    | mg              | Supplier | Boron zinc hydroxide oxide                             | 138265-88-0 |        | 0.147  | mg              |
|                      |        |                 | Supplier | Zinc Monoxide (ZnO)                                    | 1314-13-2   |        | 0.0245 | mg              |
|                      |        |                 | Supplier | 2,4,6-triamino-s-triazincompd.withs-<br>triazine-triol | 37640-57-6  |        | 0.147  | mg              |
|                      |        |                 | Supplier | Silica Amorphous (SiO2)                                | 7631-86-9   |        | 3.92   | mg              |
|                      |        |                 | Supplier | Carbon Black (C)                                       | 1333-86-4   |        | 0.049  | mg              |
|                      |        |                 | Supplier | Ortho-Cresol Novolac Resin                             | 29690-82-2  |        | 0.392  | mg              |
|                      |        |                 | Supplier | Phenolic Resin (Novolac)                               | 9003-35-4   |        | 0.2205 | mg              |
| Plating              | 0.14   | mg              | Supplier | Tin (Sn)   | 7440-31-5   |        | 0.14   | mg              |
| Wire Bond - Cu       | 0.01   | mg              | Supplier | Copper (Cu)  | 7440-50-8   |        | 0.01   | mg              |

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 signa range of distribution unless otherwise noted)